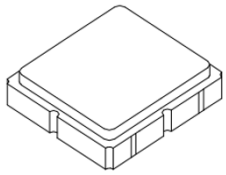
RFM
A BRAND OF AKOUSTIS

RoHS compliant

SF2170D

165 MHz SAW Filter

- ***Low Insertion Loss***
- ***3.8 X 3.8 X 1.0 mm Surface Mount Case***
- ***Single-Ended Input/Output***
- ***Complies with Directive 2002/95/EC (RoHS)***
- ***Moisture Sensitivity Level: 1***



SM3838-6

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage Between any 2 Terminals	30	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260°C for 30 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C			165		MHz
Source Impedance to Matching Network (single ended)				50		Ω
Load Impedance to Matching Network (single ended)				50		Ω
Passband Width			20	22		MHz
Rejection Referenced to Minimum Insertion Loss:						dB
10 MHz to 110 MHz			35	40		
127 MHz to 149 MHz			10	15		
190 to 210 MHz			30	40		
210 to 450 MHz			40	45		
Maximum Insertion Loss				9	10	dB
Insertion Loss Variation over -40 to 85 °C					1	dB
Amplitude Variation over 20 MHz Passband				1.0	1.5	dB_{P-P}
Group Delay Variation over 20 MHz Passband				40	80	ns_{P-P}
Absolute Group Delay at f_C				0.33		µs
Input/Output Return Loss into Matching over 20 MHz BW			6	8		dB
Operating Temperature			-40		+85	°C

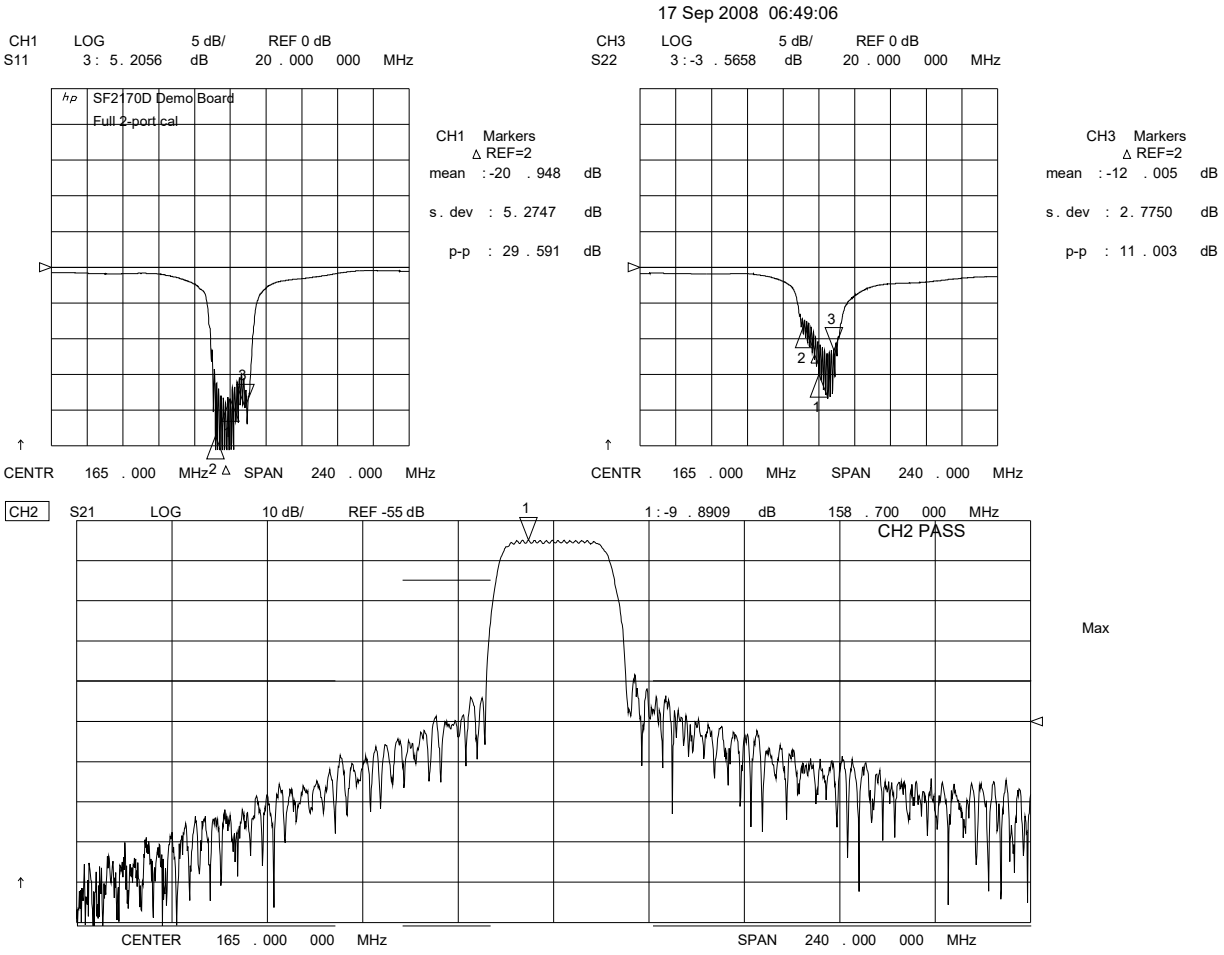
Case Style	SM3838-6 3.8 x 3.8 mm Nominal Footprint
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	865, YWWS

CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

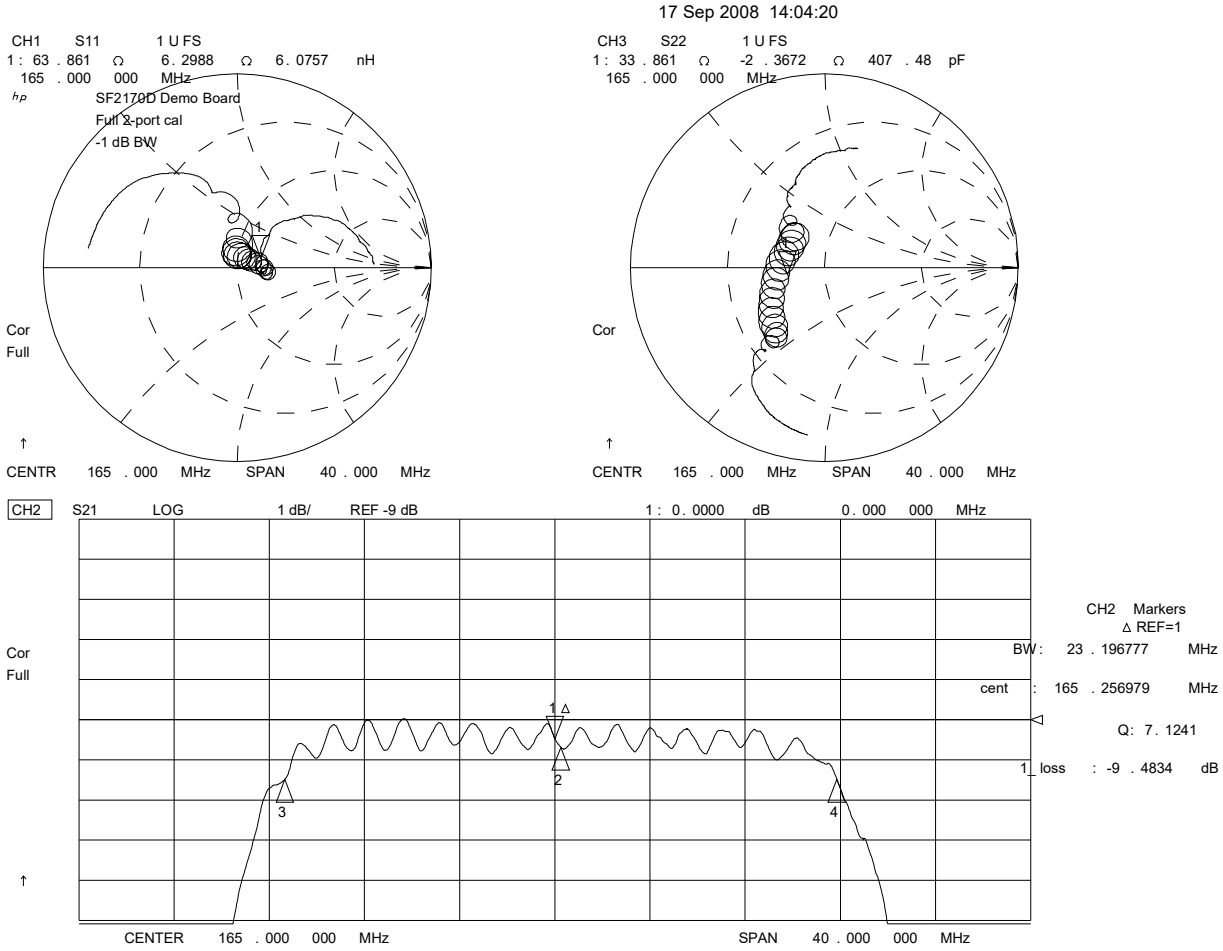
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

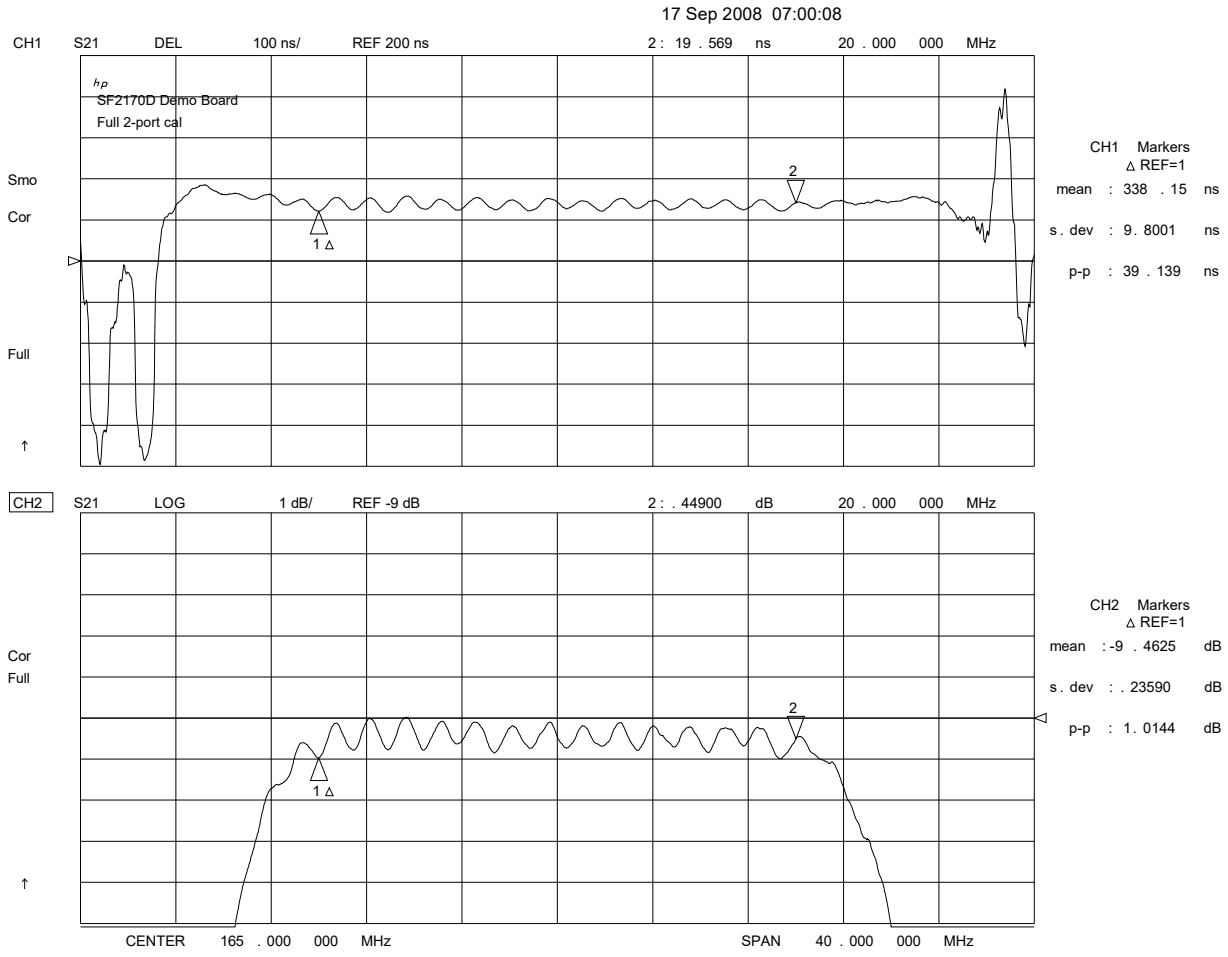
Broadband Filter Response and Return Loss (through matching network)



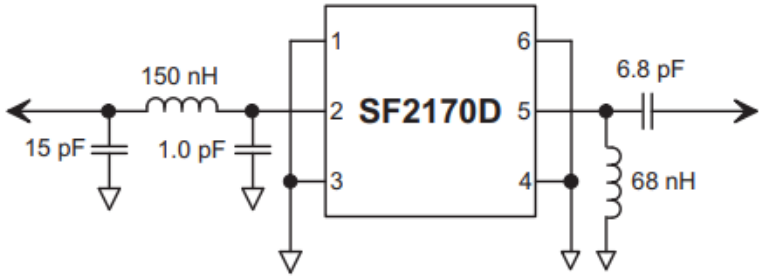
Passband Amplitude and Impedance Detail



Passband Group Delay and Amplitude Ripple

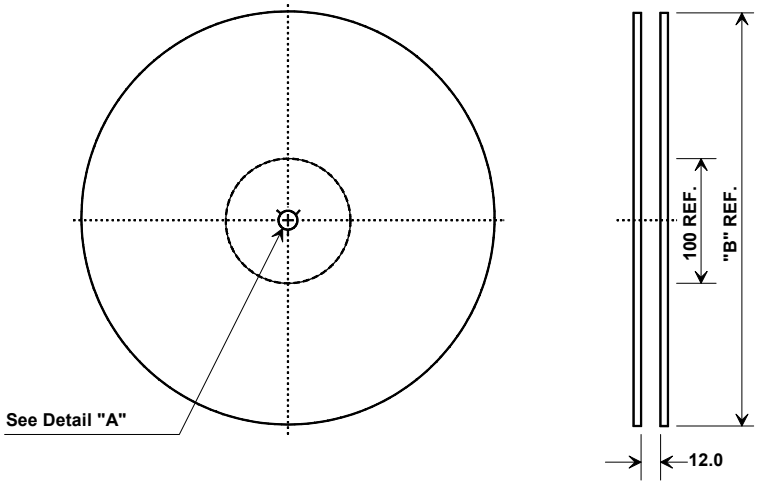


SF2170D Demo Circuit

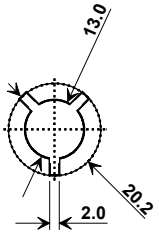


Tape and Reel Specifications

Tape and Reel Standard per ANSI/EIA-481

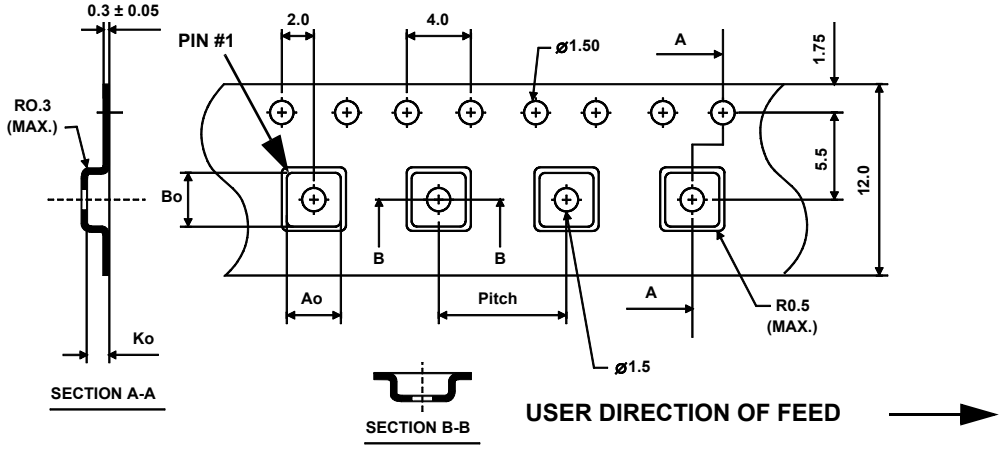


"B "		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	2000



COMPONENT ORIENTATION and DIMENSIONS

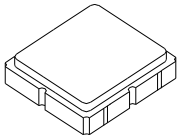
Carrier Tape Dimensions	
Ao	4.25 mm
Bo	4.25 mm
Ko	1.30 mm
Pitch	8.0 mm
W	12.0 mm

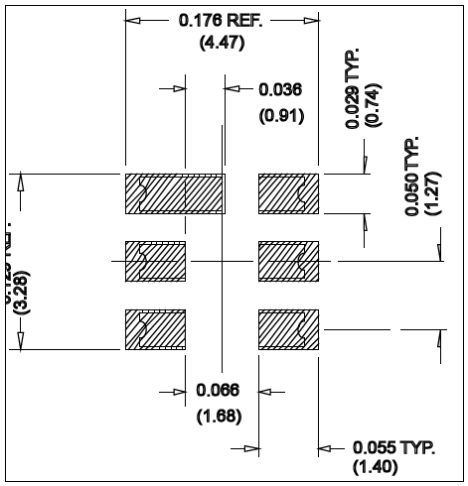


SM3838-6 Case

6-Terminal Ceramic Surface-Mount Case

3.8 X 3.8 mm Nominal Footprint





PCB Footprint

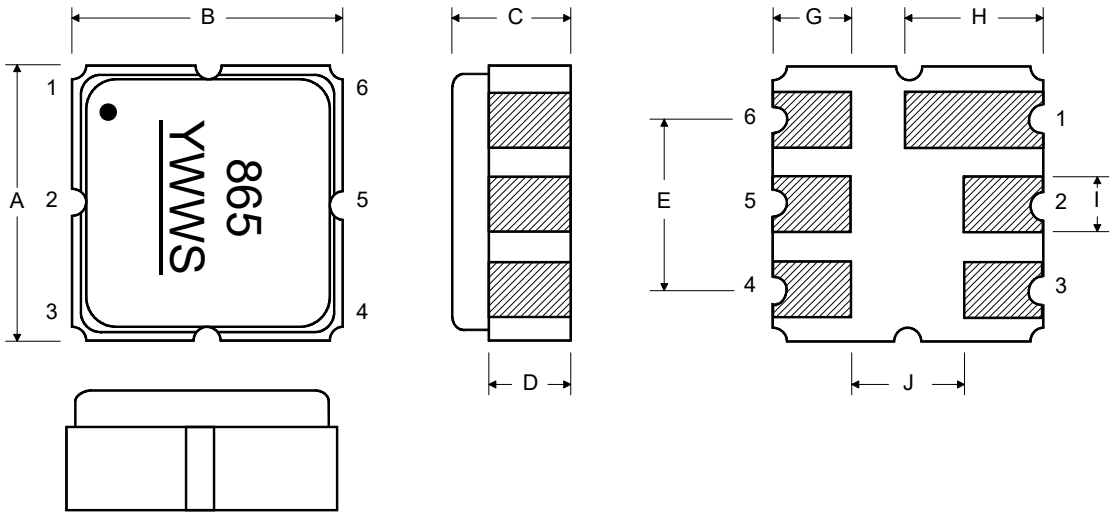
Case Dimensions						
Dimension	**mm**			**Inches**		
	Min	**Nom**	**Max**	**Min**	**Nom**	**Max**
A	3.60	3.80	4.0	0.14	0.15	0.16
B	3.60	3.80	4.0	0.14	0.15	0.16
C	1.30	1.50	1.70	0.05	0.06	0.067
D	0.95	1.10	1.25	0.037	0.043	0.05
E	2.39	2.54	2.69	0.090	0.10	0.110
G	0.90	1.0	1.10	0.035	0.04	0.043
H	1.90	2.0	2.10	0.75	0.08	0.83
I	0.50	0.6	0.70	0.020	0.024	0.028
J	1.70	1.8	1.90	0.067	0.07	0.075

Electrical Connections		
Connection		**Terminals**
Port 1	Single-ended Input	2
Port 2	Single-ended Output	5
	Ground	All others
Single Ended Operation Only		
Dot indicates Pin 1		

Materials	
Solder Pad Plating	0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel
Lid Plating	2.0 to 3.0 µm Nickel
Body	Al_2O_3 Ceramic

TOP VIEW

BOTTOM VIEW



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180ºC for 60~90 seconds.
2. Ascending time to preheating temperature 150ºC shall be 30 seconds min.
3. Heating shall be fixed at 220ºC for 50~80 seconds and at 260ºC +0/-5ºC peak (10 seconds).
4. Time: 5 times maximum.